IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Typ Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials and	rials and Mfg Information			
upplier	r Information													
Company name* Compa				ompany unique ID			Unique ID Authority				Response Date*			
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ontact N	ame	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-E	Env-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorize	d Representative*	Title - Representative			P	Phone - Representative*			Emai	Email - Representative*				
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	Requester Item Number	Mfr Iten	Mfr Item Number Mfr I		Mfr Item Name APM32 SiC power module		Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
		NVXK2PR80WXT2 APM32 SiC pow		APM32 SiC powe			2025-06-03 CPA			23620.1	mg	Each		
	cturing Process Informa		Terminal Base	Alloy	-STD-020 MS	I Poting	Dank Droce	es Rody Tampars	ture Max Time a	at Daak Tampa	vratura Numb	er of Reflow Cyo	clas	
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RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier has not independently verified information provided by others, supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	3031.4	mg	Supplier	Aluminum Nitride (AlN)	24304-00-5		606.28	mg
			Supplier	Copper (Cu)	7440-50-8		2425.1199	mg
Die Attach	61.3	mg	Supplier	Silver (Ag)	7440-22-4		1.5325	mg
			Supplier	Tin (Sn)	7440-31-5		56.7025	mg
			Supplier	Copper (Cu)	7440-50-8		3.065	mg
Die SiC	60.5	mg	Supplier	Silicon Carbide	409-21-2		60.5	mg
Lead Frame	8283.3	mg	В	Nickel (Ni)	7440-02-0		24.8499	mg
			Supplier	Iron (Fe)	7439-89-6		8.2833	mg
			Supplier	Copper (Cu)	7440-50-8		8247.4746	mg
			Supplier	Phosphorus (P)	7723-14-0		2.6921	mg
Mold Compound-Black	12075.4	mg	Supplier	Carbon Black (C)	1333-86-4		120.754	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10264.0908	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1690.556	mg
NTC	2.4	mg	Supplier	Silver (Ag)	7440-22-4		0.1932	mg
			Supplier	Tin (Sn)	7440-31-5		0.036	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		0.3631	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		1.4525	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0108	mg
			В	Nickel (Ni)	7440-02-0		0.024	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3204	mg
Plating	40.0	mg	Supplier	Tin (Sn)	7440-31-5		40	mg
Wire Bond	5.1	mg	Supplier	Silicon (Si)	7440-21-3		0.051	mg
			Supplier	Aluminum (Al)	7429-90-5		5.049	mg
Wire Bond - Al	60.7	mg	Supplier	Aluminum (Al)	7429-90-5		60.7	mg